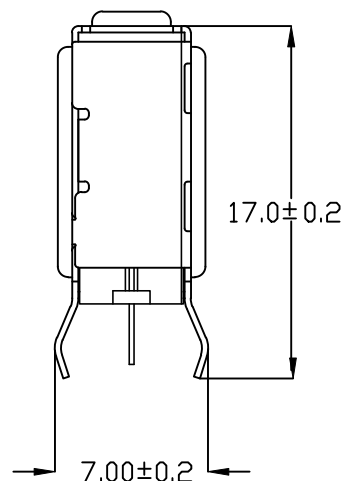
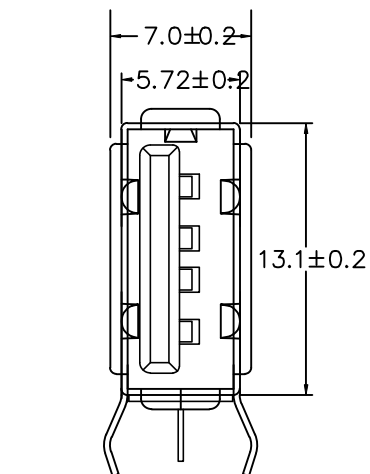
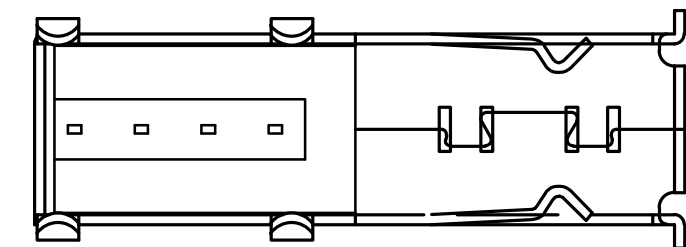
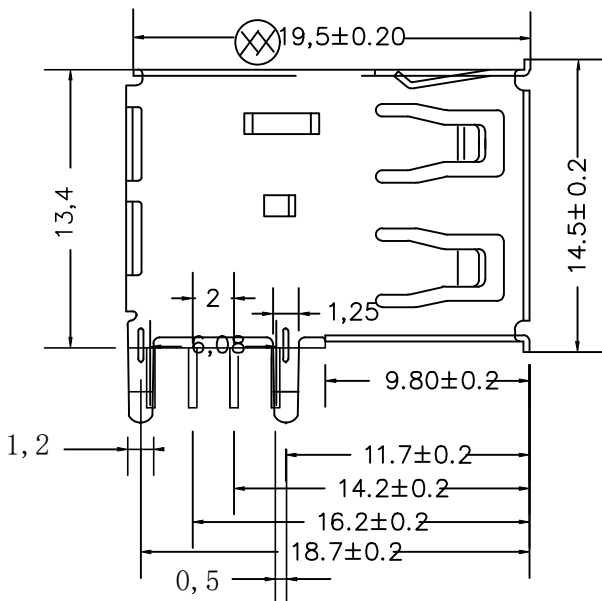




REV.	ECN NO OR DESCRIPTION	REVISED	DATE

NOTES:

1. MATERIAL SPECIFICATION

1) INSULATION MATERIAL THERMOPLASTIC.

2) SHELL: COPPER ALLOY/SPCC, T: 0.30mm
PLATING: NICKEL

3) TERMINAL: COPPER ALLOY, T: 0.25mm
PLATING: GOLD/TIN PLATED.

2. ELECTRICAL CHARACTERISTIC:

1) INSULATION RESISTANCE: 1000MΩ MIN.

2) CONTACT RESISTANCE: 30mΩ MAX.

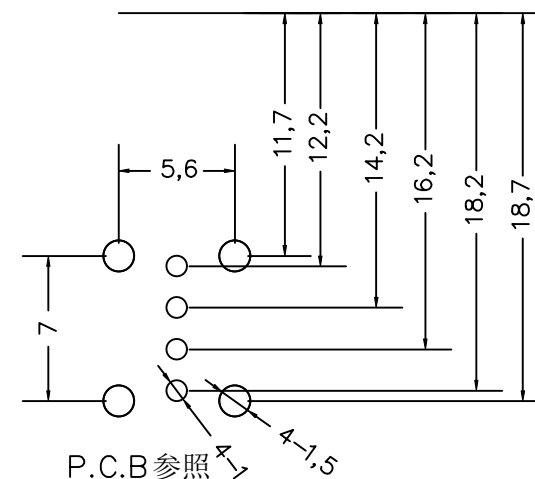
3) WITHSTANDING VOLTAGE: 500V AC.

3. MECHANICAL CHARACTERISTICS:

1) INSERTION FORCE: 3.57Kgf MAX.

2) EXTRACTION FORCE: 1.02Kgf MIN.

ORDERING INFORMATION



UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD			
DECIMALS:		ANGLES:		TITLE	
X	:±0.30	X	:±2°	DWN	xiong
X.X	:±0.20	X.X	:±1°	PART NO.	USB-U263-BJS
X.XX	:±0.10			CHKD	lee
				SCALE:1:1	UNIT: mm
				APVD	wang
				SIZE: A4	SHEET:1OF 1
				REV: A4	
CUSTOMER COPY					